## **Panasonic**

## 2SA2101

**Power Transistors** 

### Silicon PNP epitaxial planar type

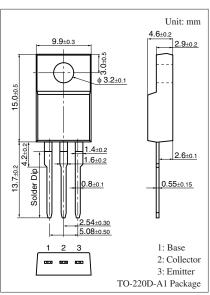
Power supply for Audio & Visual equipments such as TVs and VCRs Industrial equipments such as DC-DC converters

#### Features

- ullet High-speed switching ( $t_{stg}$ : storage time/ $t_f$ : fall time is short)
- ullet Low collector-emitter saturation voltage  $V_{\text{CE(sat)}}$
- Superior forward current transfer ratio h<sub>FE</sub> linearity
- TO-220D built-in: Excellent package with withstand voltage 5 kV guaranteed

#### ■ Absolute Maximum Ratings $T_C = 25$ °C

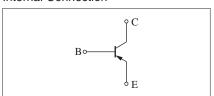
Parameter		Symbol	Rating	Unit	
Collector-base voltage (Emitter open)		V <sub>CBO</sub>	-60	V	
Collector-emitter voltage (Base open)		V <sub>CEO</sub>	-60	V	
Emitter-base voltage (Collector open)		$V_{EBO}$	-6	V	
Collector current		$I_C$	-2	A	
Peak collector current		$I_{CP}$	-4 D-t-Clos	A	
Collector power	$T_C = 25^{\circ}C$	$P_{C}$	Data She	e140.00	m
dissipation	$T_a = 25^{\circ}C$		2		
Junction temperature		T <sub>j</sub>	150	°C	
Storage temperature		$T_{stg}$	-55 to +150	°C	



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Marking Symbol: A2101

#### Internal Connection



### ■ Electrical Characteristics $T_C = 25$ ° $C \pm 3$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = -10 \text{ mA}, I_B = 0$	-60			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = -60 \text{ V}, I_E = 0$			-100	μΑ
Collector-emitter cutoff current (Base open)	$I_{CEO}$	$V_{CE} = -60 \text{ V}, I_B = 0$			-100	μΑ
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = -4 \text{ V}, I_{C} = -0.2 \text{ A}$	60			_
	h <sub>FE2</sub>	$V_{CE} = -4 \text{ V}, I_{C} = -1 \text{ A}$	80		250	_
	h <sub>FE3</sub>	$V_{CE} = -4 \text{ V}, I_{C} = -2 \text{ A}$	30			_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -2 A, I_B = -0.25 A$			- 0.6	V
Transition frequency	$f_T$	$V_{CE} = 10 \text{ V}, I_{C} = -0.1 \text{ A}, f = 10 \text{ MHz}$		100		MHz
Turn-on time	t <sub>on</sub>	$I_C = -1$ A, Resistance loaded		0.15		μs
Storage time	t <sub>stg</sub>	$I_{B1} = -0.1 \text{ A}, I_{B2} = 0.1 \text{ A}$		0.35		μs
Fall time	t <sub>f</sub>	$V_{CC} = -50 \text{ V}$		0.06		μs

 $Note)\ Measuring\ methods\ are\ based\ on\ JAPANESE\ INDUSTRIAL\ STANDARD\ JIS\ C\ 7030\ measuring\ methods\ for\ transistors.$ 

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